Modification of MIL-STD-883 TM1019 for rapid COTS path-to-flight

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Classical WCA is cost prohibitive to smaller projects



• Multiple steps

- Raw data/report -> Application formatting -> Software macro for WCRDs -> 5x factor for non-RLAT WCRDs -> making PDF to send to Cog-Es of all parameters -> determining which parameters to ask Cog-Es for specific feedback
- SEE testing can scope to mission, why not TID?
 - Down select of circuit mode like SEL or SEFI
 - Loose guideline for process based on expansive historical data and engineer insight
- JPL has a deep bench for TID
 - Similar process can be developed using 1019 as baseline
 - Tailored plan based on known technology trends





Abraham Wald's Work on Aircraft Survivability, June 1984, Journal of the American Statistical Association 79(386):259-267



Plan

- Review historical data and test plans
- Review application of data to missions
 - WCBD et al
 - Aging and other failure modes can be leveraged
- Identification of serial vulnerabilities
 - Part, circuit and system
- Develop plan to test only critical parameters
- Demonstrate on known parameters of interest (POI)



K. Sutaria, A. Ramkumar, R. Zhu and Y. Cao, "Where is the Achilles Heel under Circuit Aging," 2014 IEEE Computer Society Annual Symposium on VLSI, 2014, pp. 278-279, doi: 10.1109/ISVLSI.2014.106.

Current plan



- Compile all data on selected opamp/LREG/BJT.
- Identify high criticality parameters
- Define test plan for such
 - with infrastructure quick test leveraged from available assets
 - without infrastructure Eval cards come to mind.
- Case studies for guideline
- Develop a notional questionnaire to screen devices.
 - Can we mine RadFX for TRRs that triggered critical tests?

Chosen parts



• OPAMPs

- OP11, OP484, OP470, OP471
- Well known part with a typical sensitivity – slew and Vos
- Linear regulators
 - LM137, LP2953, LM117
 - Industry wide application with recurring sensitivities Vdropout, e.g.
- Bipolar junction transistors
 - 2N2222, 2N2907, 2N3501
 - Easy lay-up for proof-of-concept





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Vulnerable Parameters - Bipolar Junction Transistors

JPL 10mR(Si)/S TO 100KRAD(Si)			RTS 10mr(Si)/s to 100krad(Si)			RTS 10mr(Si)/s to 100krad(Si)		
2N3501			2N2222			2N2907		
	biased	unbiased		biased	unbiased		biased	unbiased
HFE1 @ VCE=10V, IC=100uA	F	F	HFE1 @ VCE=10V, IC=100uA*	F	F	HFE1 @ VCE=10V, IC=100uA*	F	F
HFE2 @ VCE=10V, IC=1mA	F	F	HFE2 @ VCE=10V, IC=1mA	F	F	HFE2 @ VCE=10V, IC=1mA	F	F
HFE3 @ VCE=10V, IC=10mA	F	F	HFE3 @ VCE=10V, IC=10mA	F	F	HFE3 @ VCE=10V, IC=10mA	F	F
HFE4 @ VCE=10V, IC=50Ma	F	F	HFE4 @ VCE=10V, IC=150mA	F	F	HFE4 @ VCE=10V, IC=150mA	F	F
VCESAT1 @ IC=1mA, IB=.1mA	Р	Р	VCE(sat)1 @ IC=1mA, IB=0.1mA	Р	Р	VCE(sat)1 @ IC=1mA, IB=0.1mA	Р	Р
VCESAT2 @ IC=10mA, IB=1mA	Р	Р	VCE(sat)2 @ IC=10mA, IB=1mA	Р	Р	VCE(sat)2 @ IC=10mA, IB=1mA	Р	Р
VCESAT3 @ IC=150mA, IB=15mA	Р	Р	VBE(sat)1 @ IC=1mA, IB=0.1mA	Р	Р	VBE(sat)1 @ IC=1mA, IB=0.1mA	Р	Р
VBESAT @ IC=10mA, IB=1mA	Р	Р	VBE(sat)2 @ IC=10mA, IB=1mA	Р	Р	VBE(sat)2 @ IC=10mA, IB=1mA	Р	Р
VBSAT2 @ IC=50mA, IB=5mA	Р	Р						
Biased parts were slightly worse			Biased parts were slightly worse			Biased parts were slightly worse		
than unbiased.			than unbiased.			than unbiased.		

Vulnerable parameters - Operational Amplifiers

JPL@ 10mR/s 100K			JPL 10mR/s TO 50KRAD			JPL 10mR/S TO 50KRAD			RTS 10mR/s TO 100KRAD		
OP11			OP484			OP470			OP471		
	biased	unbiased		biased	unbiased		biased	unbiased		biased	unbiased
VIO @ ±15V	Р	F	VOS @ ±15V	F*	F	VOS @ ±15V	F*	F*	IB+ @ VS=+/-15V	F	F
IIO @ ±15V	F	F	IIO @ ±15V	F*	F	IIO @ ±15V	F*	F*	IB- @ VS=+/-15V	F	F
IB+@±15V	F	F	IB+@±15V	F	F	IB+ @ ±15V	F	F	AVO @ VS=+/-15V RL=10kΩ	F	F
IB- @ ±15V	F	F	IB - @ ±15V	F	F	IB- @ ±15V	F	F	CMRR @ VS=+/-15V, VCM=+/-11V	F*	F*
CMRR @ ±15V	F	F	CMRR @ ±15V	F*	F*	CMRR @ ±15V VCM=+/-11V	F	F			
AVO @ ±15V RL=2K	Р	F	PSRR @ ±15V VS= ±2V > ±15V	F*	F*	AVS @ ±15V RL=2K	F*	F			
			AVS @ ±15V RL=2K VO=+/-10V	F*	F*	AVS @ ±15V RL=10K	F	F			
			AVS @ ±15V RL=10K VO=+/-10V	F*	F*	SR+ @ ±15V RL=2K	F*	F			
						SR- @ ±15V RL=2K	Р	F*			
						PSRR VS=+/-2V > +/-15V	F* (CH 2)	F			
Unbiased were WC.			Unbiased were WC.			Unbiased were WC.			Unbiased were WC.		
			* 99/90 only			* 99/90 only			* 99/90 only		

Vulnerable Parameters – Linear Regulators

N	A	Ż	A
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JPL 10mR(Si)/s up to 15Krad(Si)			JPL 5mR(Si)/s TO 10.5KRAD(Si)			JPL 5mR(Si)/s TO 30KRAD(Si)		
LM137			LP2953 LDO Regulator			LM117 LDO Regulator	biased	unbiased
	biased	unbiased		biased	unbiased	Vref @ VD=5V IL=10mA	F	
VREF @ 10 mA (AL)	F	F	Vout @ Vin=6V	F	F	Vref VIN=5.50V IL=5.0mA, 500mA	F	
VREF VIN=-4.25V IL= 5mA	F	F	Vout @ VD=.3 thru 1V il=1Ma TO 200Ma	F	F	Vref VIN=30.00V IL=5.0mA, 72.7mA	F	
VR Line -4.25V to -30V	F	F	Dropout @ 1ma, 50mA, 100mA, 250mA	F	F	'VR Line Vdiff=3V to 28.75V	F	
Load Reg @ Vin=-6.25, IL=5mA to 500mA	F	F	Gnd Pin current @ 1ma, 50mA, 100mA, 250mA	F	F	'IADJ VIN=4.25V IL=5.0mA	F	
IBIAS VIN=-4.25V IL= 5mA	F	F	Vref @ 2.3V, 5V, 6V IL = 1mA thru 200mA	F	F	'IADJ VIN=4.25V IL=500.0mA	F	
IBIAS VIN=-6.25V IL= 5mA	F	F	Feedback Current	F	F	'IADJ vs Line	F	
ladj Vin=4.25 V to 30V	F	F				'IADJ vx Load	F	
ladj IL=5mA to 500mA	F	F				'Min Load VO=2.5V VIN=5.50V	F	
Min Load VIN=-4.25V	F	F				Vout VIN=5.00V IL= 25mA, 75mA	F	
Min Load VIN=-14.25V	F	F				Vout VIN=12.00V IL= 25mA, 75mA	F	
Min Load VIN=30V	F	F				Dropout IL= 5mA, 50mA, 100mA	F	
						Dropout IL=150mA, 200mA, 200mA, 250mA, 300mA	F	
LoadReg passes at lower current range or			The unbiased parts were more noticeable					
high Vin voltage and even lower current range			in terms of the degradation.					
The unbiased parts were more noticeable			Voltage and current levels played a part at what					
in terms of the degradation.			rad level they began to fail.					



Identified vulnerable circuit and systems

Circuits

- High gain circuits
 - Used in instruments and communications
- Current monitoring
 - Sensitive to minor changes
- Low leakage circuits
 - Switches and power MOSFETs

Systems

- Instrumentation apps

 Need precision
- Power modules and battery systems
 - Need precise current measurement and low leakage
- Radios and radars
 Need high gain

Critical Paths and Readiness For Testing

- Convergent parameters for part, circuit and applications
- Assists in place can allow for quick turn testing
- Eval boards can extract parameters with minimal system engineering

Worst Case Failures		CURRENT INFRASTRU	RE		WITHOUT CURRENT INFRASTRURE			
Offset Voltage	LTS2020 W/2101 FB			В	Build Eval board w/feedback loop using			
Offset Current		Unless part comes in odd			ow noise Op-amps along with some			
Input Bias current		package we should be fine			ower supplies, DMMs, pico ammeters			
Common Mode Rejection Ra	atio	with our existing hardware	e.	aı	nd scope.			
Open Loop Gain								
		OnAmn						
		oprimp						
	П.							
WORST CASE FAILURES	T	festing with Infrastruc	ture	:	Testing without Infrastructure			
HFE		Eagle 300, B1500, B1505, HP4	1256		Can be tested using the B1500 or B1505			
		-			or the HP4256.			
					If none of the above units are available			
I would recommend testing	1				then we need 2 or 3 power supplies			
the VCE(sat) parameter as well					several DMMs and a need to fab an			
as the leakage parameters ex.		BIT			eval board, with sockets and a few			
IEBO, ICBO					resistors			
WC Parameters	Test	ing with Infrastructure			Testing without Infrastructure			
VREF	Eagle 300				If the regulator is a 3 terminal device it can			
Vout	LTS2020				be tested using the B1500, B1505 or the			
IADJ					HP4256.			
LINE REG		T D e e			If the Regulator has multiple pins with			
LOAD REG		LKeg			various functions then we would require			
Min Load		0			addition power supples, DIVINIS and a scope.			
					A eval board would definitely need to be			
					built.			

Work to be done



- Test plan and execution of only critical parameter
 - With and without infrastructure
 - Separate analysis of SE tools needed
- Cost and risk comparison
 - Including risk buydown "formula"
- Compare/contrast with other tools
 - SEAM (Systems Engineering and Assurance Modeling)
 - SPICE and derivatives



Conclusion



Comparing MEAN for lb+ (Vcc = 5V, Vcm = 0V, OpAmp#2)

- Reduce test time and cost
- Increase use of COTS
- Develop IP for COTS fast track





BACK UP

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